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APR APPLICANT:
Applicant:

<u>IN THE UNITED STATES PATENT AND TRADEMARK OFFICE</u>

Group Art No.: 2835

10/067,698

Harold Syring

Examiner: Tolin, Gerald P.

#4/A 4-14-03 Roberts-

Filed:

Application No:

2/4/2002

Re: RESPONSE

For: "I

"Device for Cooling CPU Chip"

Our Ref: B-4491 619503-1

Date: April 2, 2003

Honorable Commissioner of Patents and Trademarks Washington, D.C. 2023l

Dear Sir:

This paper is filed in response to the Office Action dated January 2, 2003. All comments and amendments made herein are made without prejudice.

IN THE CLAIMS

Please delete claim 14 and amend claims 1, 7, 13, 15, 16 and 18 to read as follows:



- 1. A device for cooling a CPU chip disposed on a chassis comprising:
 - a heat sink disposed on the CPU chip;
- a bracket, having at least one pivot portion and at least one retention portion, rotatably mounted on the chassis by the pivot portion; and
 - a fan disposed on the bracket, wherein the fan is relatively closer to the heat sink when the bracket engages with the chassis by the retention portion, and wherein the fan is relatively farther away from the heat

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